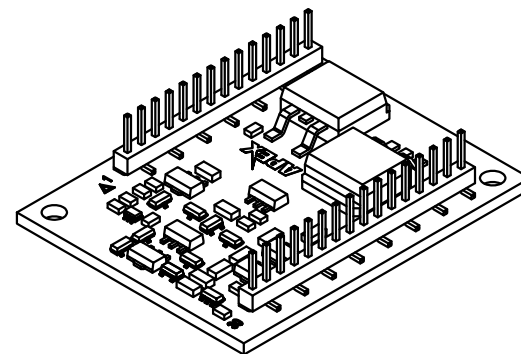
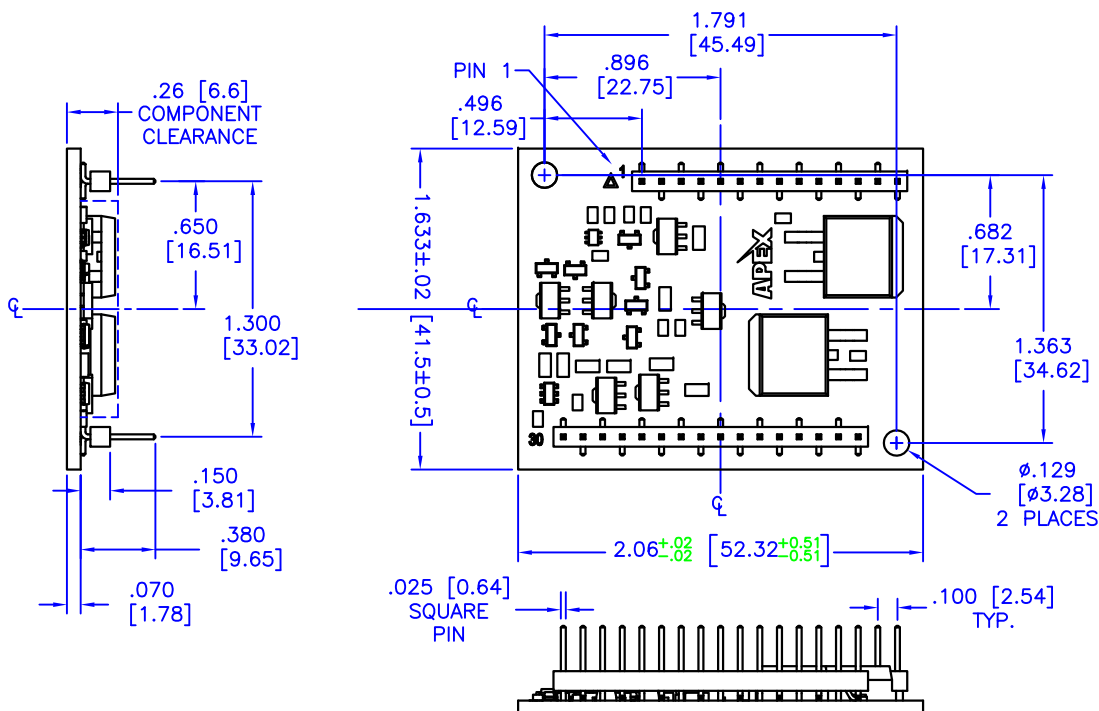


4

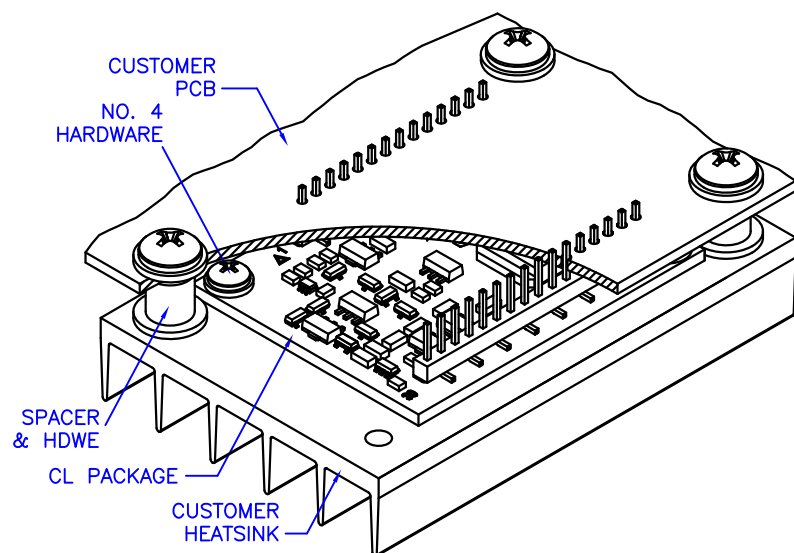
3

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SUGGESTED MOUNTING METHOD



NOTES:

1. Dimensions are inches; alternate units are [mm].
2. Recommended PCB hole diameter for pins: .050"
3. 2 oz. copper over 600V dielectric over aluminum substrate
4. Tin-nickel plated phosphor bronze pins
5. Package weight: 0.56 oz. [15.9 g]
6. Mount with #4 or equivalent screws.
7. It is not recommended that mounting of the package rely on the pins for mechanical support. The mounting method shown does not represent a specific design solution or the only way to mount the package.
8. Care must be exercised in designing the mating board, to avoid interference among board components.

TOLERANCES - UNLESS OTHERWISE SPECIFIED
 .XX = $\pm .01$ [.254]
 .XXX = $\pm .005$ [.127]
 ANG. = $\pm 5^\circ$



TITLE: MODULAR 30-pin DIP, 1.3" SPACING
 SUBJECT: PACKAGE OUTLINE
 ENGINEER: D-M
 DRAWN BY: R.MOR
 DCA: 13225
 SHL 1 OF 1

MODEL: CL
 FILENAME: CL
 REV: D
 DATE: 29MAY13

CL

4

3

2

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